

DATA SHEET

SMV1263 Series: Hyperabrupt Junction Tuning Varactors

Applications

- Low-noise and wideband UHF and VHF VCOs
- High-volume, low-cost battery-powered tuning circuits

Features

- High capacitance ratio at low reverse voltage
- Packages rated MSL1, 260 °C per JEDEC J-STD-020



Description

The SMV1263 series of silicon hyperabrupt junction varactor diodes are designed for 3 V platforms. The high capacitance ratio and low reverse voltage of these varactors make them attractive for low phase noise Voltage Controlled Oscillators (VCOs) in wireless systems up to and over 2.5 GHz.

Table 1 describes the packages and markings of the SMV1263 series of varactors.

DATA SHEET • SMV1263 SERIES VARACTORS

Table 1. Packaging and Marking

		
Single	Common Cathode	Single
SOD-882 Green™	SC-70 Green™	SC-79 Green™
SMV1263-040LF Marking: EN1	SMV1263-074LF Marking: EN3	♦SMV1263-079LF Marking: Cathode and KH
LS = 0.45 nH	LS = 1.4 nH	LS = 0.7 nH



The Pb-free symbol or "LF" in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

Table 2. SMV1263 Series Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Typical	Maximum	Units
Reverse voltage	V _R			20	V
Forward current	I _F			20	mA
Power dissipation	P _{DIS}			250	mW
Operating temperature	T _{OP}	–55		+125	°C
Storage temperature	T _{STG}	–55		+150	°C
Electrostatic discharge: Human Body Model (HBM), Class 1A	ESD			500	V

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 3. SMV1263 Series Electrical Specifications¹
(T_{OP} = 25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Reverse current	I _R	V _R = 15 V			20	nA
Capacitance	C _T	F = 1 MHz V _R = 0.5 V V _R = 2.5 V	6.2 2.3	6.7 2.6	7.2 2.9	pF pF
Capacitance ratio	C _{TR}	C _T @ 0.5 V/C _T @ 2.5 V	2.3	2.5		–
Series resistance	R _S	F = 900 MHz, V _R = 1 V			1.2	Ω
Breakdown voltage	V _{BR}	I _R = 10 μA	20			V

¹ Performance is guaranteed only under the conditions listed in this table.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMV1263 varactors are provided in Table 2. Electrical specifications are provided in Table 3. Typical capacitance values are listed in Table 4. Typical performance characteristics of the SMV1263 varactors are illustrated in Figures 1 and 2.

The SPICE model for the SMV1263 varactors is shown in Figure 3 and the associated model parameters are provided in Table 5.

Package dimensions are shown in Figures 4 to 8 (even numbers), and tape and reel dimensions are provided in Figures 5 to 9 (odd numbers).

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMV1263 series of varactors are rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. They can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 4. Capacitance vs Reverse Voltage

VR (V)	CT (pF)
0	8.87
0.25	7.68
0.50	6.68
0.75	5.83
1.00	5.11
1.25	4.50
1.50	3.99
1.75	3.54
2.00	3.17
2.25	2.84
2.50	2.57
2.75	2.33
3.00	2.12
3.25	1.94
3.50	1.79
3.75	1.65
4.00	1.54
4.25	1.44
4.50	1.35
4.75	1.27
5.00	1.20

Typical Performance Characteristics

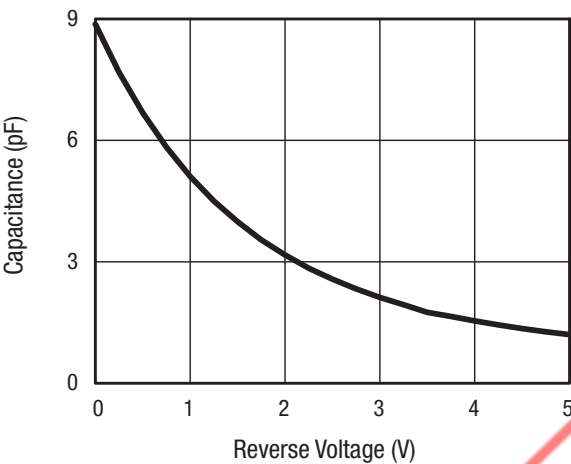


Figure 1. Capacitance vs Voltage

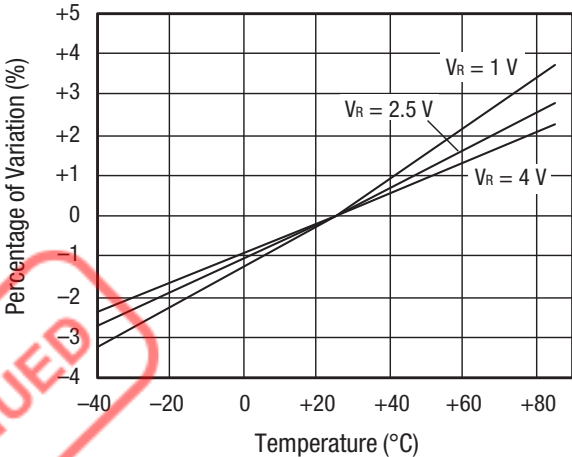


Figure 2. Relative Capacitance Change vs Temperature

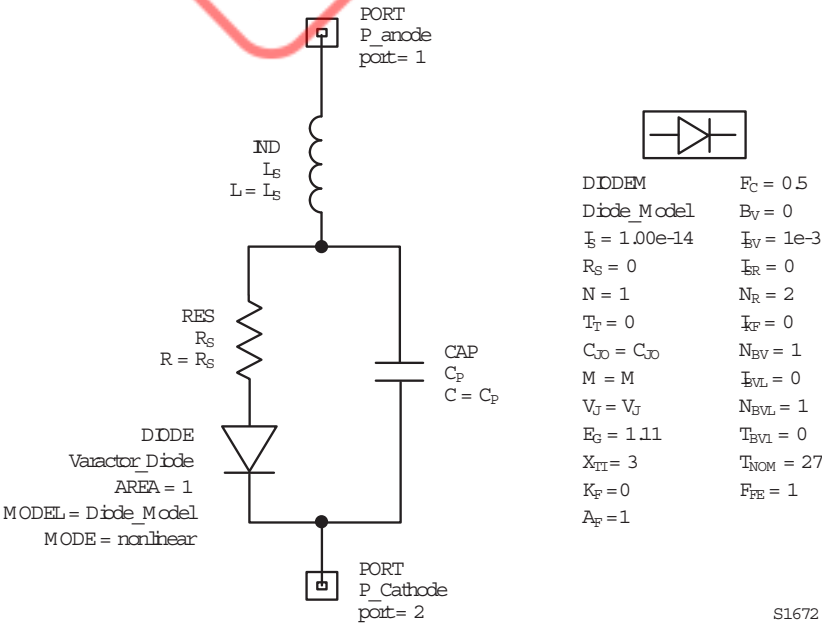


Figure 3. SPICE Model

Table 5. SPICE Model Parameters

Part Number	Cjo (pF)	Vj (V)	M	Cp (pF)	Rs (Ω)	Ls (nH)
SMV1263 series	8.2	15	9.5	0.67	1.2	1.7

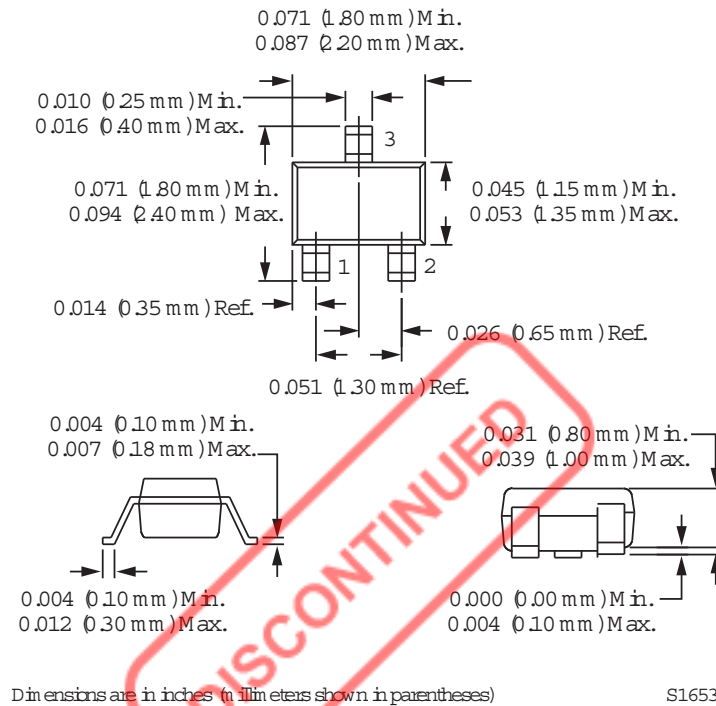
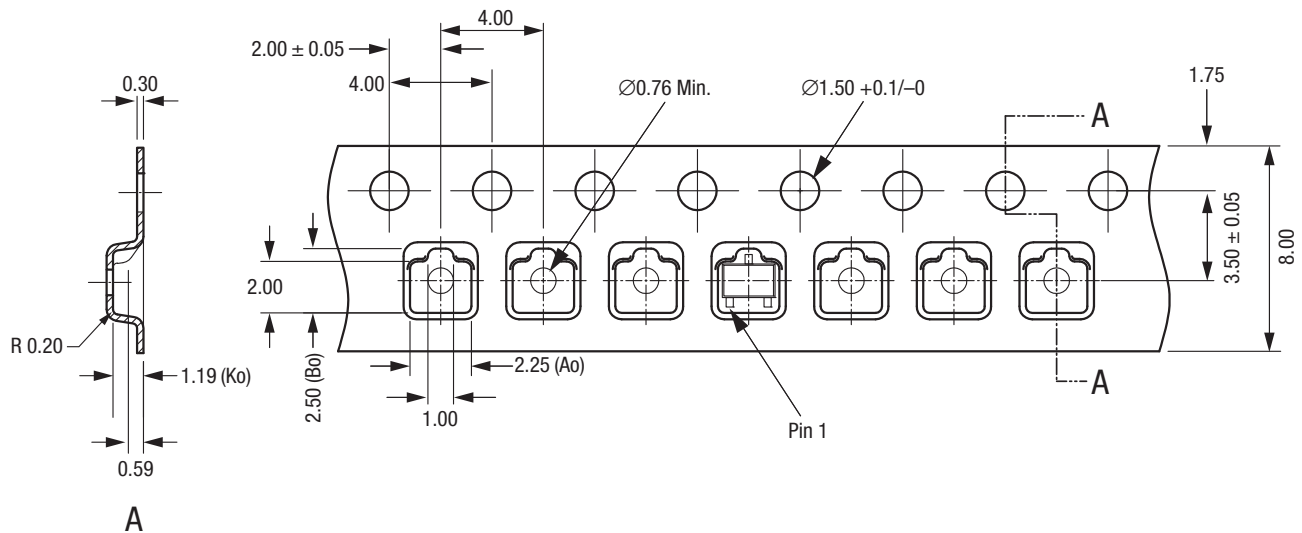


Figure 4. SC-70 Package Dimensions



Notes:

1. Carrier tape: black conductive polystyrene bakeable material at 125 °C.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.40 mm width.
4. ESD surface resistivity is $\geq 1 \times 10^4$ and approx. $\leq 1 \times 10^8$ Ohms/square per EIA, JEDEC TNR Specification.
5. All measurements are in millimeters.

S1685b

Figure 5. SC-70 Tape and Reel Dimensions

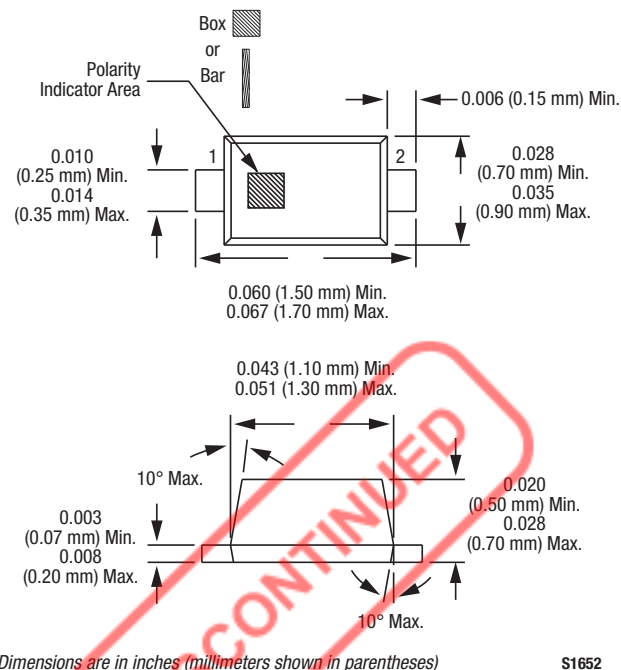


Figure 6. SC-79 Package Dimensions

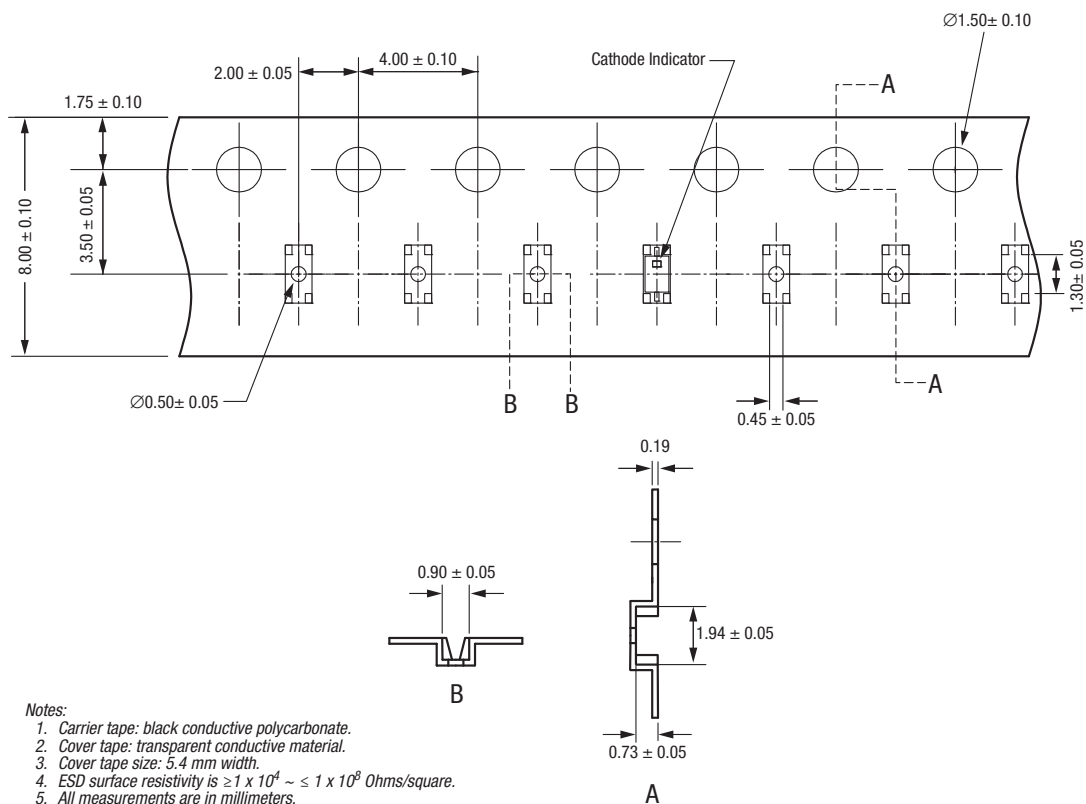
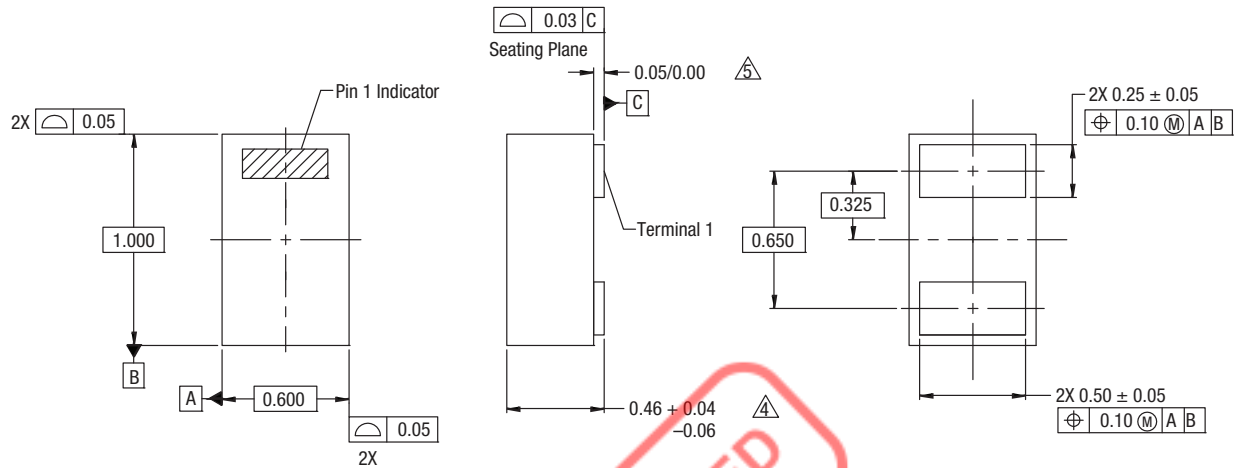


Figure 7. SC-79 Tape and Reel Dimensions

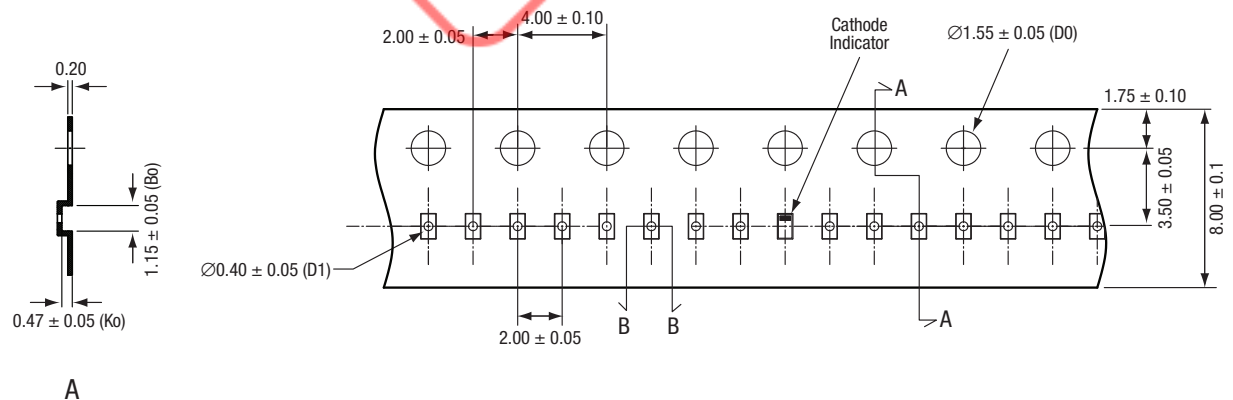


NOTES:

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. These packages are used principally for discrete devices.
4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
5. This dimension is primarily terminal plating, but does not include small metal protrusion.

Y1410

Figure 8. SOD-882 Package Dimensions



Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape: transparent conductive material.
3. Cover tape size: 5.4 mm width.
4. ESD surface resistivity is $\geq 1 \times 10^4 \sim \leq 1 \times 10^8$ Ohms/square.
5. All dimensions are in millimeters.

S1922

Figure 9. SOD-882 Tape and Reel Dimensions



Copyright © 2002-2005, 2009- 2011, 2014-2015, 2018, 2026, Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc., and its subsidiaries ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks' Terms and Conditions of Sale.

THE INFORMATION IN THIS DOCUMENT AND THE MATERIALS AND PRODUCTS DESCRIBED THEREIN ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED.

SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not designed, intended, authorized, or warranted for use or inclusion in life support or life endangering applications, devices, or systems where failure or inaccuracy might cause death or personal injury. Skyworks customers agree not to use or sell the Skyworks products for such applications, and further agree to, without limitation, fully defend, indemnify, and hold harmless Skyworks and its agents from and against any and all actions, suits, proceedings, costs, expenses, damages, and liabilities including attorneys' fees arising out of or in connection with such improper use or sale.

Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of Skyworks' published specifications or parameters. Customers are solely responsible for their products and applications using the Skyworks products.

"Skyworks" and the Skyworks Starburst logo are registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.